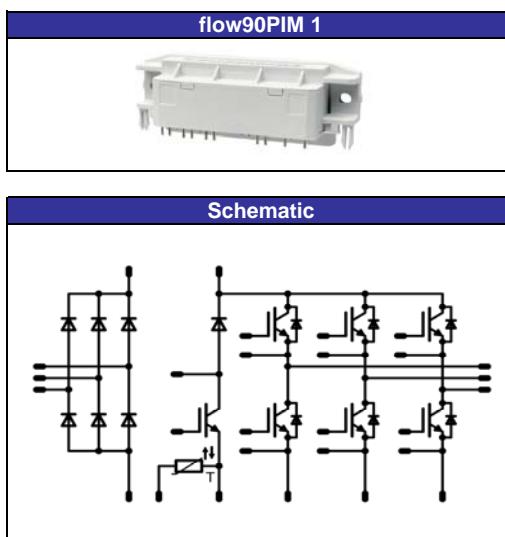


flow90PIM 1
1200V/15A

Features
<ul style="list-style-type: none"> • Trench Fieldstop Technology IGBT4 for low saturation loss • Supports design with 90° mounting angle between heatsink and PCB • Clip-in PCB mounting • Clip or screw on heatsink mounting
Target Applications
<ul style="list-style-type: none"> • Industrial drives
Types
<ul style="list-style-type: none"> • V23990-P630-A40



Maximum Ratings

 $T_j=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Input Rectifier Diode

Repetitive peak reverse voltage	V_{RRM}		1600	V
DC forward current	I_{FAV}	$T_j=T_{j\max}$	27 36	A
Surge forward current	I_{FSM}		220	A
I^2t -value	I^2t	$t_p=10\text{ms}$	200	A^2s
Power dissipation per Diode	P_{tot}	$T_j=T_{j\max}$	33 50	W
Maximum Junction Temperature	$T_{j\max}$		150	$^\circ\text{C}$

Inverter Transistor

Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_c	$T_j=T_{j\max}$	21 26	A
Repetitive peak collector current	I_{Cpulse}	t_p limited by $T_{j\max}$	45	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$, $T_j \leq T_{j\max}$	45	A
Power dissipation per IGBT	P_{tot}	$T_j=T_{j\max}$	62 95	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{sc} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	10 800	μs V
Maximum Junction Temperature	$T_{j\max}$		175	$^\circ\text{C}$

Maximum Ratings

$T_j=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter FWD				
Peak Repetitive Reverse Voltage	V_{RRM}	$T_j=25^\circ\text{C}$	1200	V
DC forward current	I_F	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	14 17	A
Repetitive peak forward current	I_{FRM}	t_p limited by $T_j\text{max}$	30	A
Power dissipation per Diode	P_{tot}	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	44 67	W
Maximum Junction Temperature	$T_j\text{max}$		175	$^\circ\text{C}$
Brake Transistor				
Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_C	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	13 15	A
Repetitive peak collector current	I_{CPuls}	t_p limited by $T_j\text{max}$	24	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$, $T_j \leq T_{j\text{max}}$	24	A
Power dissipation per IGBT	P_{tot}	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	46 70	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	10 800	μs V
Maximum Junction Temperature	$T_j\text{max}$		175	$^\circ\text{C}$
Brake FWD				
Peak Repetitive Reverse Voltage	V_{RRM}	$T_j=25^\circ\text{C}$	1200	V
DC forward current	I_F	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	14 19	A
Repetitive peak forward current	I_{FRM}	t_p limited by $T_j\text{max}$	18	A
Power dissipation per Diode	P_{tot}	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	31 48	W
Maximum Junction Temperature	$T_j\text{max}$		150	$^\circ\text{C}$
Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{op}		-40...+($T_{j\text{max}} - 25$)	$^\circ\text{C}$
Insulation Properties				
Insulation voltage	V_{is}	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

Characteristic Values

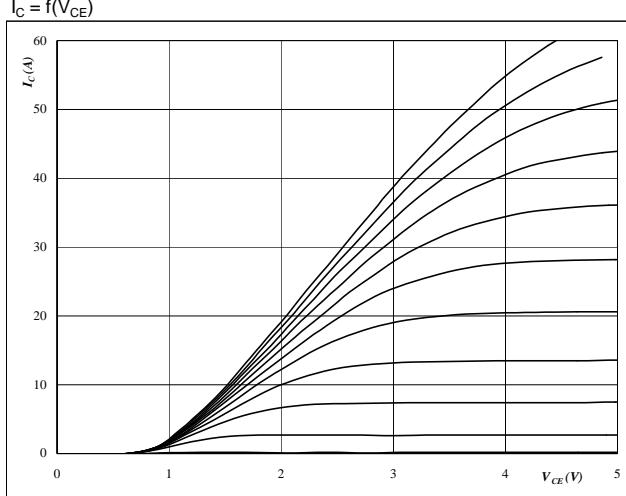
Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V] or V_{DS} [V]	I_c [A] or I_F [A] or I_D [A]	T_j	Min	Typ	Max	
Input Rectifier Diode										
Forward voltage	V_F				25	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1	1,22 1,20	1,5	V
Threshold voltage (for power loss calc. only)	V_{to}				25	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,93 0,81		V
Slope resistance (for power loss calc. only)	r_t				25	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		12 16		$\text{m}\Omega$
Reverse current	I_r			1600		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			0,05	mA
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						2,14		K/W
Inverter Transistor										
Gate emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE}=V_{GE}$			0,0005	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		15	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1,6	1,86 2,22	2,1	V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	1200		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,002	mA
Gate-emitter leakage current	I_{GES}		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			120	nA
Integrated Gate resistor	R_{gint}							none		Ω
Turn-on delay time	$t_{d(\text{on})}$	$R_{\text{off}}=32 \Omega$ $R_{\text{on}}=32 \Omega$	± 15	600	15	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		85 93		ns
Rise time	t_r					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		30 32		
Turn-off delay time	$t_{d(\text{off})}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		214 285		
Fall time	t_f					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		83 142		
Turn-on energy loss per pulse	E_{on}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,17 1,78		mWs
Turn-off energy loss per pulse	E_{off}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,89 1,53		
Input capacitance	C_{ies}	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		900		pF
Output capacitance	C_{oss}							80		
Reverse transfer capacitance	C_{rss}							55		
Gate charge	Q_{Gate}		±15	960	15	$T_j=25^\circ\text{C}$		80		nC
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						1,52		K/W
Inverter FWD										
Diode forward voltage	V_F				15	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1,2	1,80 1,72	2,2	V
Peak reverse recovery current	I_{RRM}	$R_{\text{on}}=32 \Omega$	± 15	600	15	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		10 13		A
Reverse recovery time	t_{rr}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		297 505		ns
Reverse recovered charge	Q_{rr}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,51 3,04		μC
Peak rate of fall of recovery current	$\frac{di(\text{rec})}{dt}$ max					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		50 41		$\text{A}/\mu\text{s}$
Reverse recovered energy	E_{rec}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,59 1,22		mWs
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						2,15		K/W

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit	
			V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V] or V_{DS} [V]	I_c [A] or I_F [A] or I_D [A]	T_j	Min	Typ	Max		
Brake Transistor											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0003	$T_j=25^\circ C$ $T_j=150^\circ C$	5	5,8	6,5	V	
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		8	$T_j=25^\circ C$ $T_j=150^\circ C$	1,6	1,86 2,15	2,1	V	
Collector-emitter cut-off incl diode	I_{CES}		0	1200		$T_j=25^\circ C$ $T_j=150^\circ C$			0,001	mA	
Gate-emitter leakage current	I_{GES}		20	0		$T_j=25^\circ C$ $T_j=150^\circ C$			120	nA	
Integrated Gate resistor	R_{gint}							none		Ω	
Turn-on delay time	$t_{d(on)}$	$R_{goff}=32 \Omega$ $R_{gon}=32 \Omega$	± 15	600	8	$T_j=25^\circ C$ $T_j=150^\circ C$	60			ns	
Rise time	t_r					$T_j=25^\circ C$ $T_j=150^\circ C$	27				
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ C$ $T_j=150^\circ C$	179				
Fall time	t_f					$T_j=25^\circ C$ $T_j=150^\circ C$	247				
Turn-on energy loss per pulse	E_{on}					$T_j=25^\circ C$ $T_j=150^\circ C$	68				
Turn-off energy loss per pulse	E_{off}					$T_j=25^\circ C$ $T_j=150^\circ C$	137				
Input capacitance	C_{ies}					$T_j=25^\circ C$ $T_j=150^\circ C$	0,51				
Output capacitance	C_{oss}	$f=1MHz$	0	25		$T_j=25^\circ C$	0,79			mWs	
Reverse transfer capacitance	C_{rss}						0,45				
Gate charge	Q_{Gate}						0,78				
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1 W/mK$						2,05		K/W	
Brake FWD											
Diode forward voltage	V_F				8	$T_j=25^\circ C$ $T_j=125^\circ C$	1	1,76 1,69	2,3	V	
Reverse leakage current	I_r			1200		$T_j=25^\circ C$ $T_j=125^\circ C$			250	μA	
Peak reverse recovery current	I_{RRM}	$R_{gon}=32 \Omega$	± 15	600	8	$T_j=25^\circ C$ $T_j=125^\circ C$	6			A	
Reverse recovery time	t_{rr}					$T_j=25^\circ C$ $T_j=125^\circ C$	8			ns	
Reverse recovered charge	Q_{rr}					$T_j=25^\circ C$ $T_j=125^\circ C$	374				
Peak rate of fall of recovery current	$dI_{(rec)max}/dt$					$T_j=25^\circ C$ $T_j=125^\circ C$	637				
Reverse recovery energy	E_{rec}					$T_j=25^\circ C$ $T_j=125^\circ C$	1,01			μC	
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1 W/mK$				$T_j=25^\circ C$ $T_j=125^\circ C$	1,01			mWs	
							39			$A/\mu s$	
							34				
							0,46				
							0,96				
							2,23			K/W	
Thermistor											
Rated resistance	R					$T_j=25^\circ C$		22000		Ω	
Deviation of R100	$\Delta R/R$	$R100=1486 \Omega$				$T_c=100^\circ C$	-5		5	%	
Power dissipation	P					$T_c=25^\circ C$		200		mW	
Power dissipation constant						$T_j=25^\circ C$		2		mW/K	
B-value	$B_{(25/50)}$	Tol. ±3%				$T_j=25^\circ C$		3950		K	
B-value	$B_{(25/100)}$	Tol. ±3%				$T_j=25^\circ C$		3996		K	
Vincotech NTC Reference						$T_j=25^\circ C$			B		

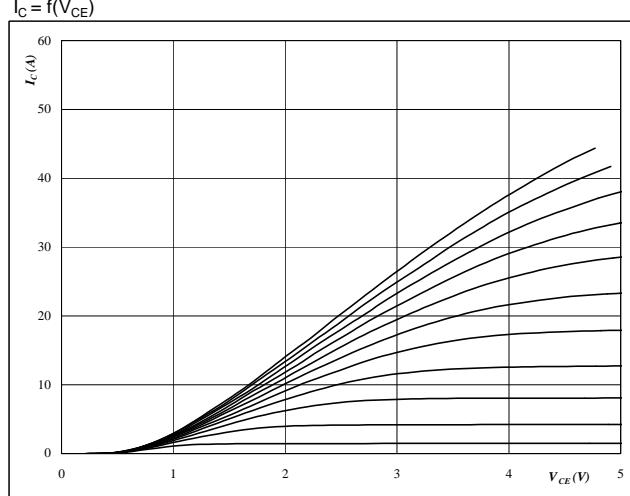
Output Inverter

Figure 1
Typical output characteristics
 $I_C = f(V_{CE})$



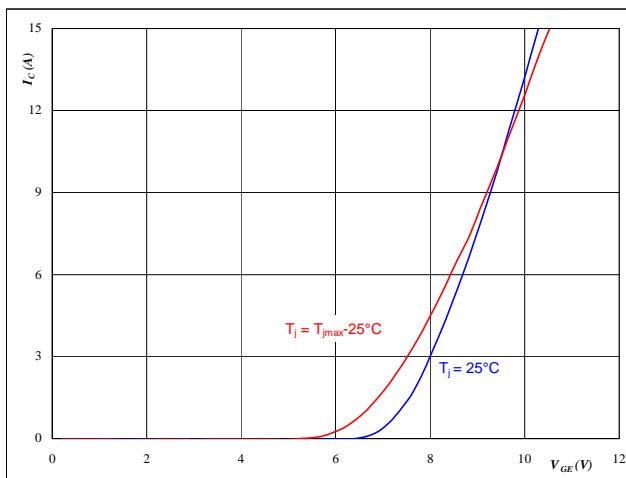
At
 $t_p = 250 \mu s$
 $T_j = 25^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2
Typical output characteristics
 $I_C = f(V_{CE})$



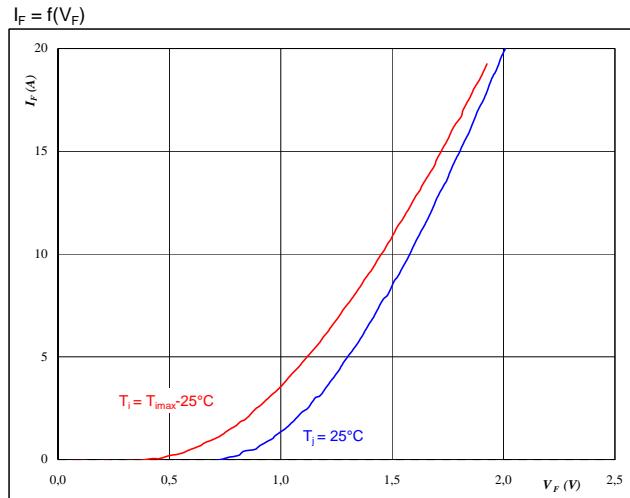
At
 $t_p = 250 \mu s$
 $T_j = 150^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3
Typical transfer characteristics
 $I_C = f(V_{GE})$



At
 $t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4
Typical diode forward current as a function of forward voltage
 $I_F = f(V_F)$



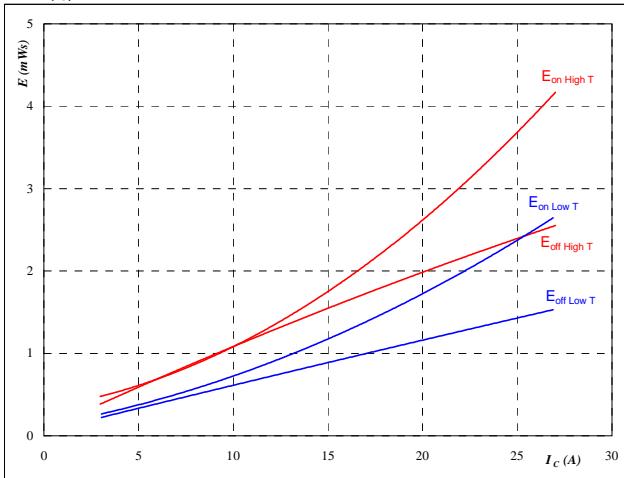
At
 $t_p = 250 \mu s$

Output Inverter

Figure 5

**Typical switching energy losses
as a function of collector current**

$$E = f(I_C)$$



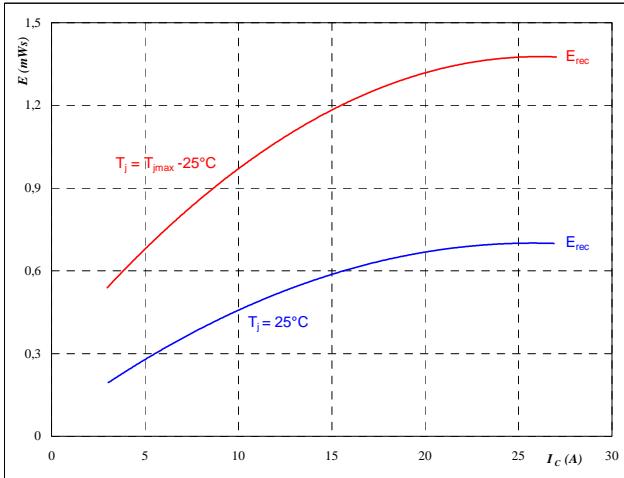
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \\ R_{goff} &= 32 \quad \Omega \end{aligned}$$

Figure 7

**Typical reverse recovery energy loss
as a function of collector current**

$$E_{rec} = f(I_C)$$



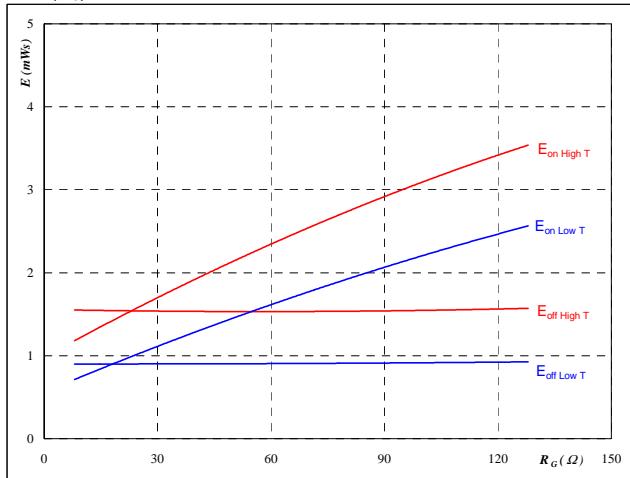
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

Figure 6

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



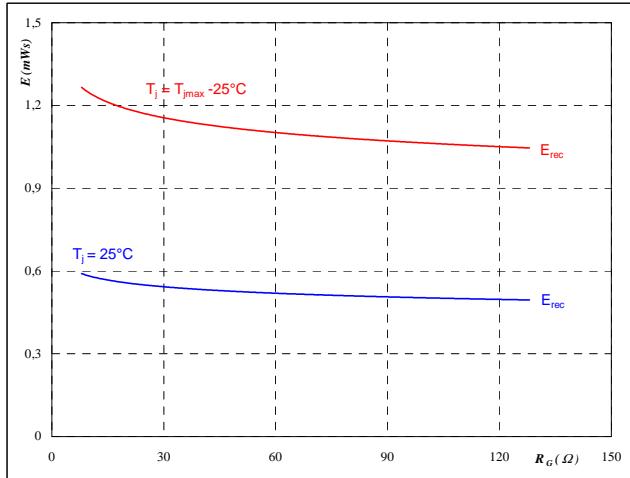
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 15 \quad \text{A} \end{aligned}$$

Figure 8

**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



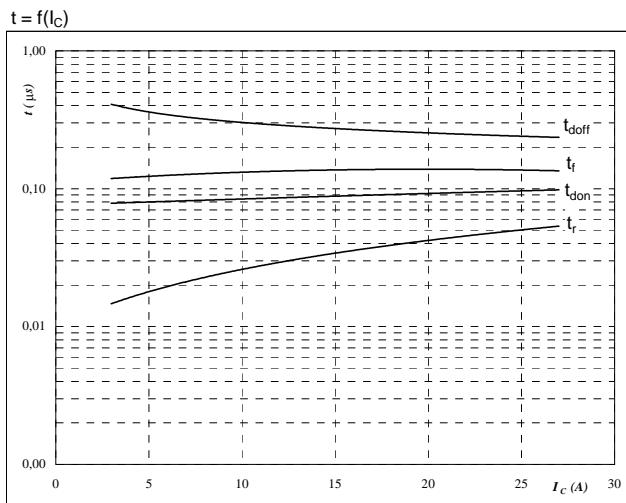
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 15 \quad \text{A} \end{aligned}$$

Output Inverter

Figure 9

Typical switching times as a function of collector current
 $t = f(I_C)$

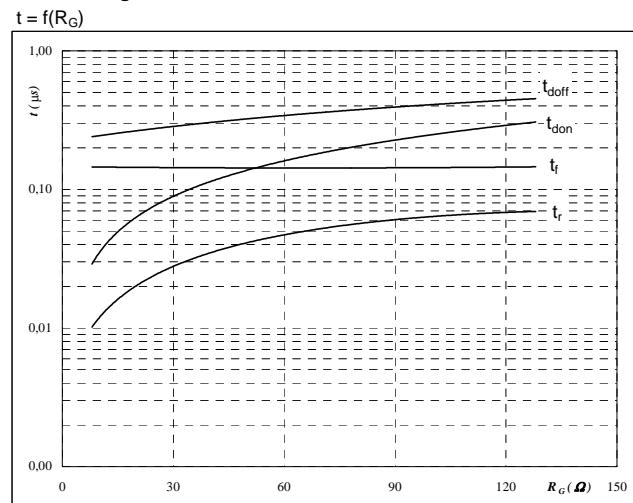


With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 32 \Omega$
 $R_{goff} = 32 \Omega$

Figure 10

Typical switching times as a function of gate resistor
 $t = f(R_G)$



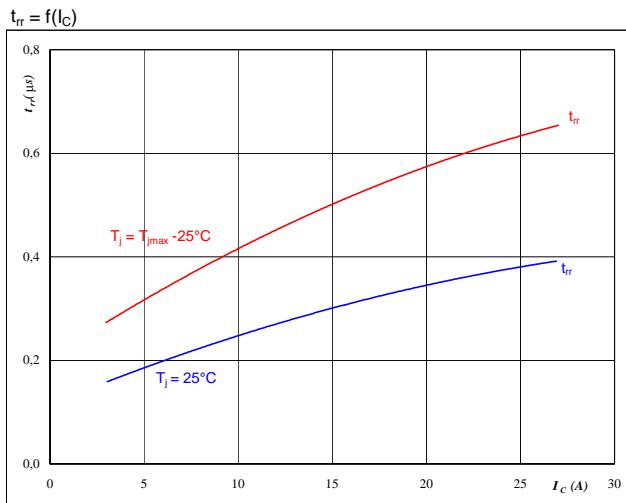
With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 15 \text{ A}$

Figure 11

Output inverter FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



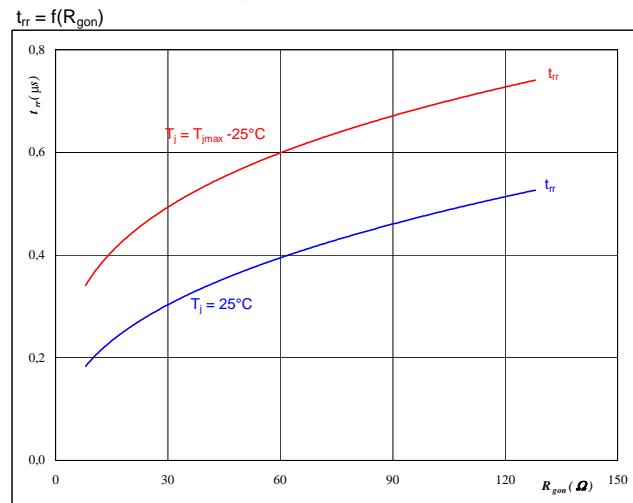
At

$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 32 \Omega$

Figure 12

Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



At

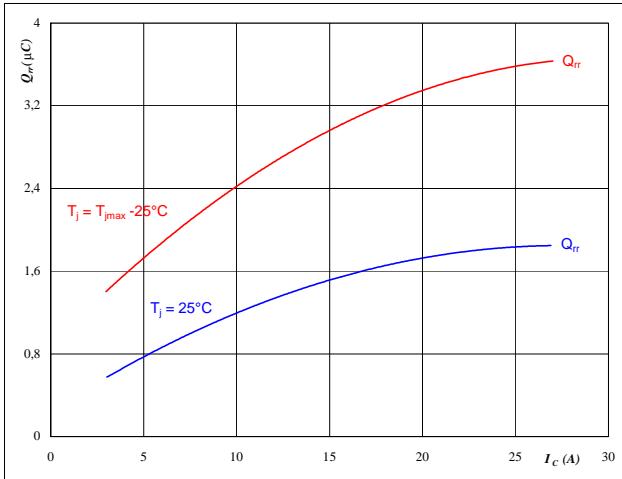
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_R = 600 \text{ V}$
 $I_F = 15 \text{ A}$
 $V_{GE} = \pm 15 \text{ V}$

Output Inverter

Figure 13

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$


At

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

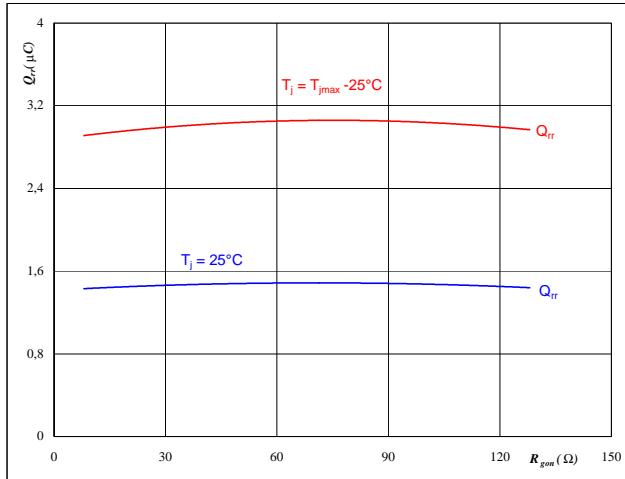
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 32 \quad \Omega$$

Output inverter FWD
Figure 14

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$


At

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

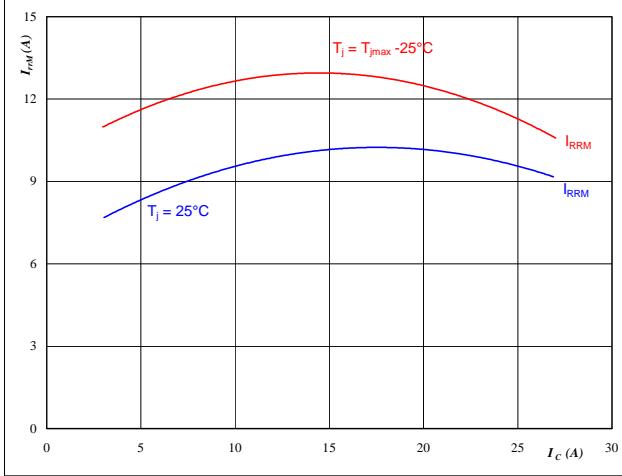
$$I_F = 15 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

Figure 15
Output inverter FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$


At

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

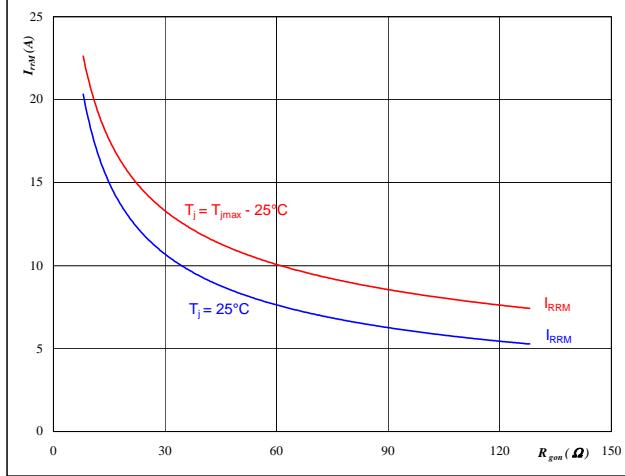
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 32 \quad \Omega$$

Figure 16
Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$


At

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

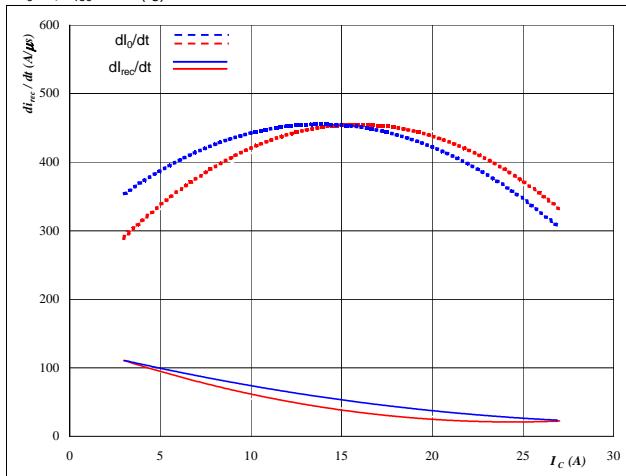
$$I_F = 15 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

Output Inverter

Figure 17

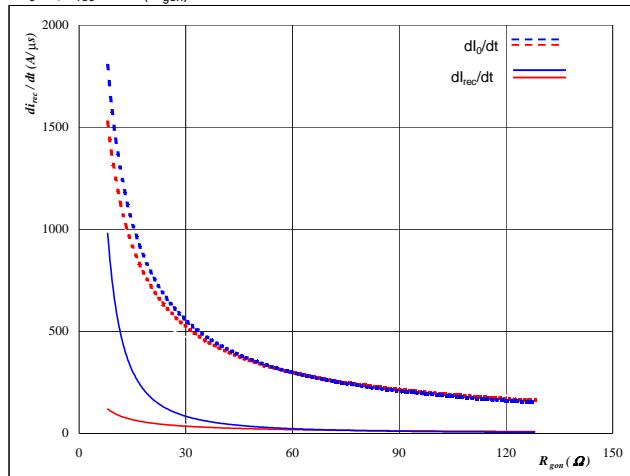
Typical rate of fall of forward
and reverse recovery current as a
function of collector current
 $dI_0/dt, dI_{rec}/dt = f(I_C)$


At

$T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

Output inverter FWD
Figure 18

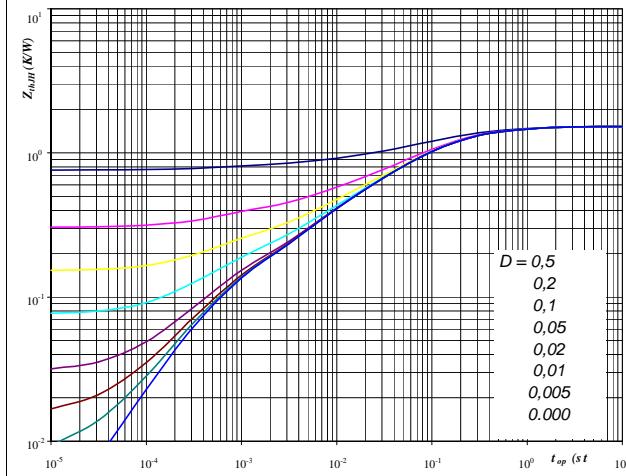
Typical rate of fall of forward
and reverse recovery current as a
function of IGBT turn on gate resistor
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$


At

$T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 15$ A
 $V_{GE} = \pm 15$ V

Figure 19

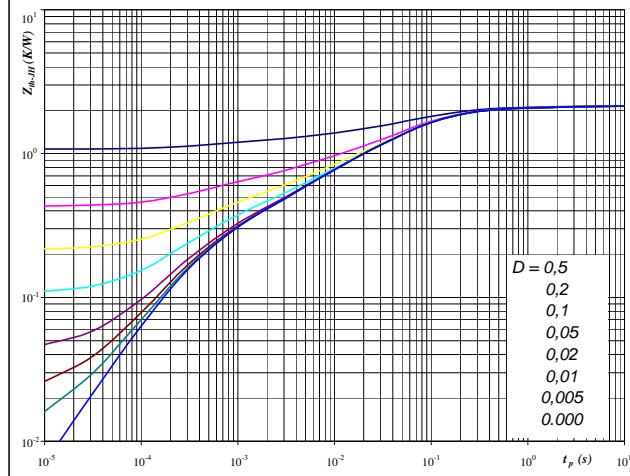
IGBT transient thermal impedance
as a function of pulse width
 $Z_{thJH} = f(t_p)$


At

$D = t_p / T$
 $R_{thJH} = 1.52$ K/W $R_{thJH} = 1.23$ K/W

Output inverter IGBT
Figure 20

FWD transient thermal impedance
as a function of pulse width
 $Z_{thJH} = f(t_p)$


At

$D = t_p / T$
 $R_{thJH} = 2.15$ K/W $R_{thJH} = 1.74$ K/W

IGBT thermal model values

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,15	1,0E+00	0,12	8,2E-01
0,59	1,6E-01	0,48	1,3E-01
0,44	4,3E-02	0,36	3,5E-02
0,23	7,0E-03	0,19	5,7E-03
0,11	5,4E-04	0,09	4,4E-04

FWD thermal model values

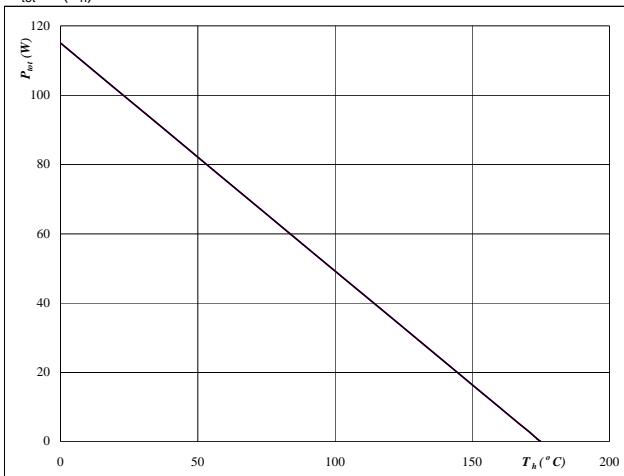
Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,03	7,7E+00	0,03	6,3E+00
0,11	1,1E+00	0,09	8,8E-01
0,39	1,8E-01	0,32	1,4E-01
0,90	5,5E-02	0,73	4,5E-02
0,37	8,9E-03	0,30	7,2E-03
0,16	1,8E-03	0,13	1,5E-03

Output Inverter

Figure 21

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$

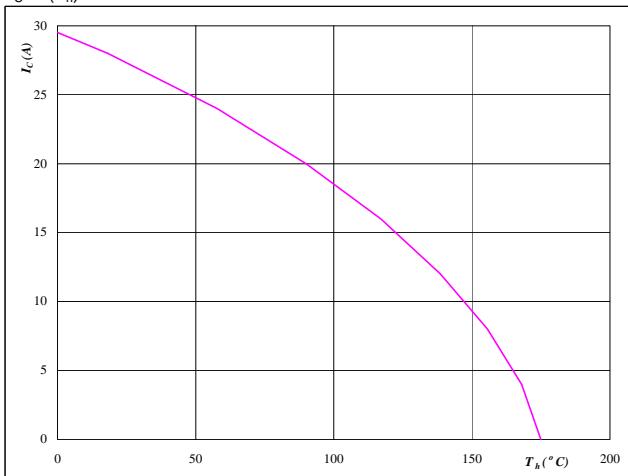

At

$$T_j = 175 \quad ^\circ\text{C}$$

Output inverter IGBT
Figure 22

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$


At

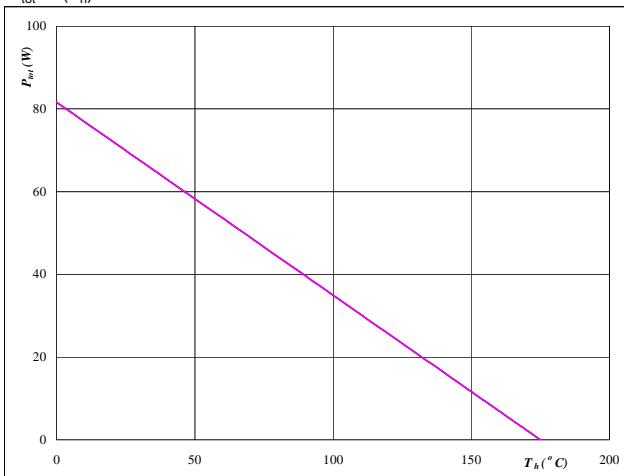
$$T_j = 175 \quad ^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

Figure 23
Output inverter FWD

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$

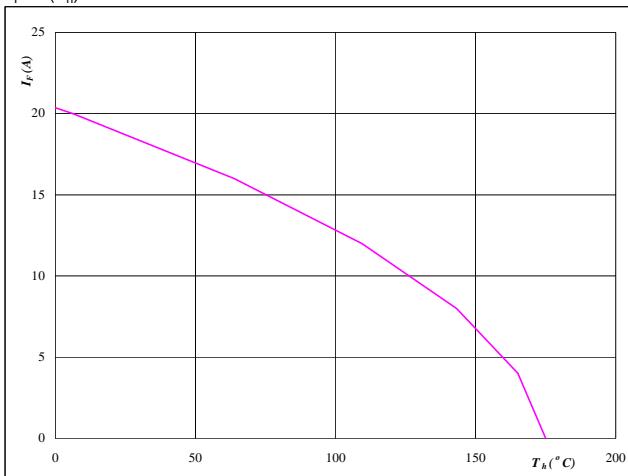

At

$$T_j = 175 \quad ^\circ\text{C}$$

Figure 24
Output inverter FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$


At

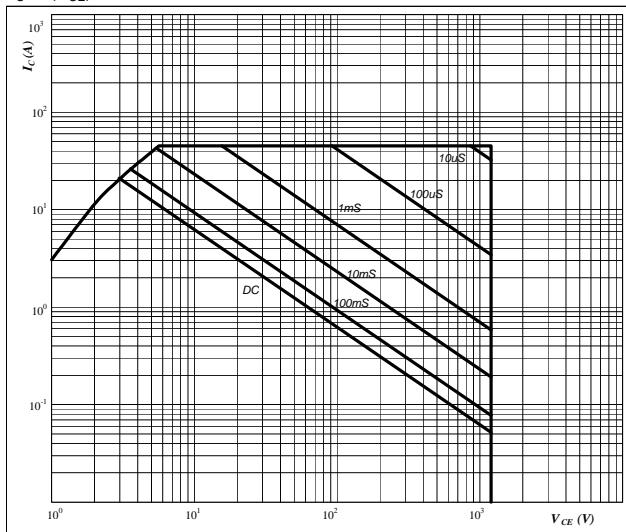
$$T_j = 175 \quad ^\circ\text{C}$$

Output Inverter

Figure 25

**Safe operating area as a function
of collector-emitter voltage**

$$I_C = f(V_{CE})$$


At

D = single pulse

T_h = 80 °C

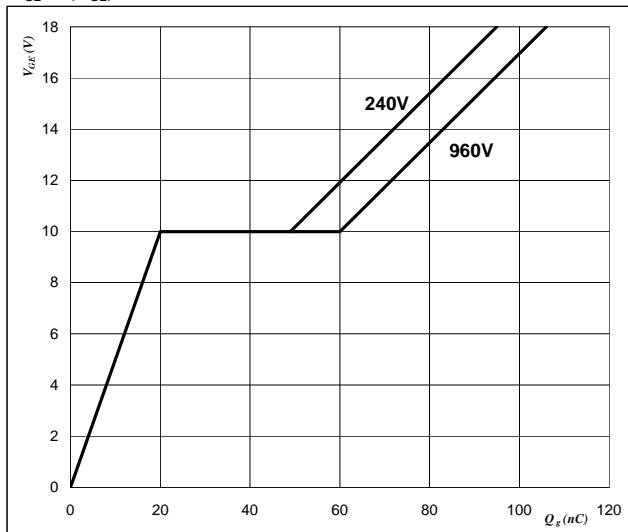
V_{GE} = ±15 V

T_j = T_{jmax} °C

Output inverter IGBT
Figure 26

Gate voltage vs Gate charge

$$V_{GE} = f(Q_{GE})$$

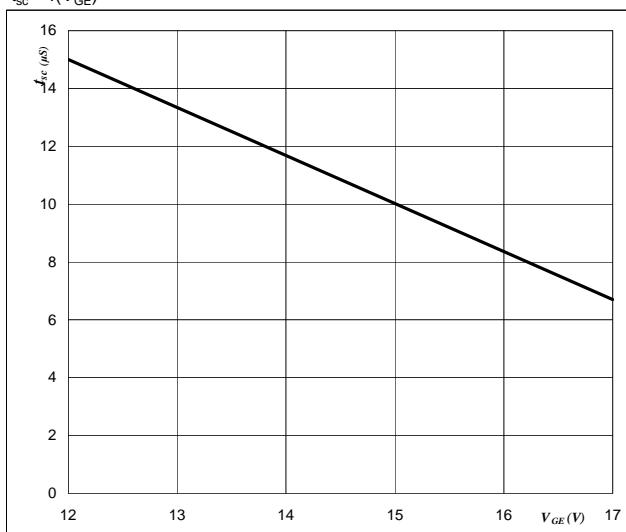

At

I_C = 15 A

Figure 27

**Short circuit withstand time as a function of
gate-emitter voltage**

$$t_{sc} = f(V_{GE})$$


At

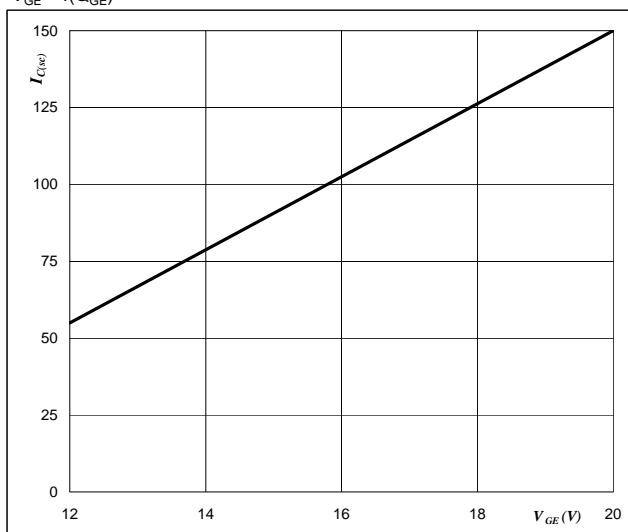
V_{CE} = 600 V

T_j ≤ 25 °C

Output inverter IGBT
Figure 28

**Typical short circuit collector current as a function of
gate-emitter voltage**

$$I_{CSC} = f(V_{GE})$$

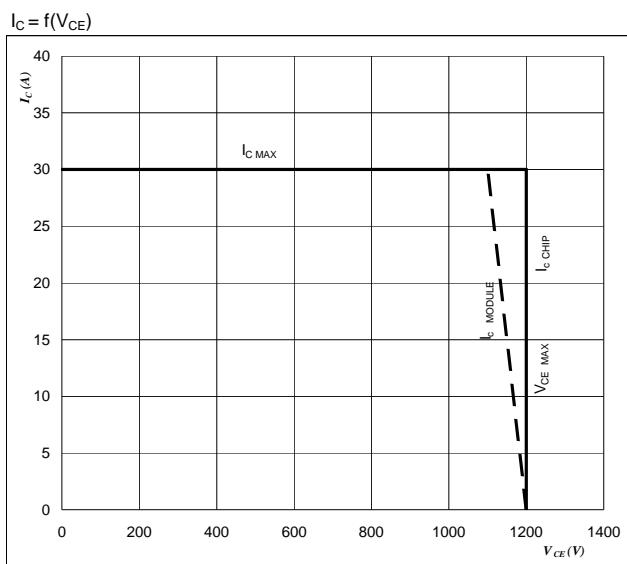

At

V_{CE} ≤ 600 V

T_j = 150 °C

Figure 29

IGBT

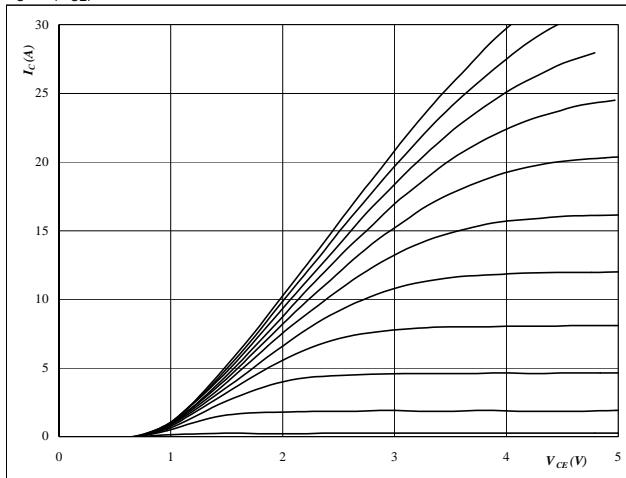
Reverse bias safe operating area**At** $T_j = T_{jmax} - 25 \quad {}^\circ\text{C}$

Switching mode : 3phase SPWM

Brake

Figure 1
Typical output characteristics

$$I_C = f(V_{CE})$$


At

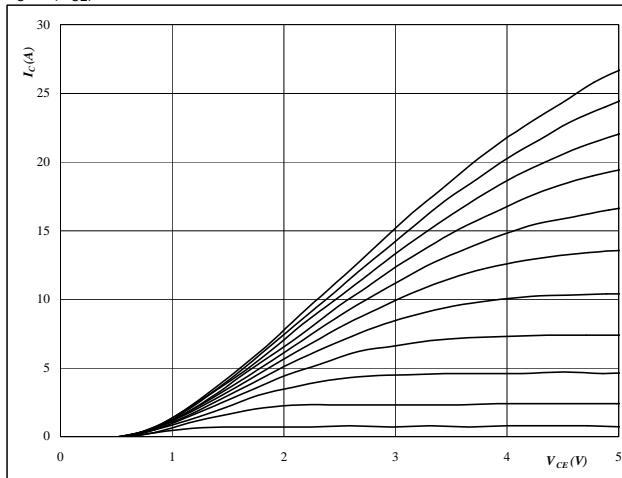
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

 V_{GE} from 7 V to 17 V in steps of 1 V

Brake IGBT
Figure 2
Typical output characteristics

$$I_C = f(V_{CE})$$


At

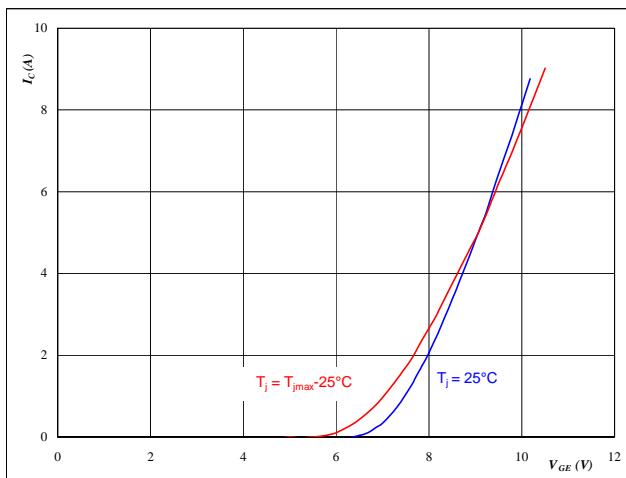
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3
Typical transfer characteristics

$$I_C = f(V_{GE})$$

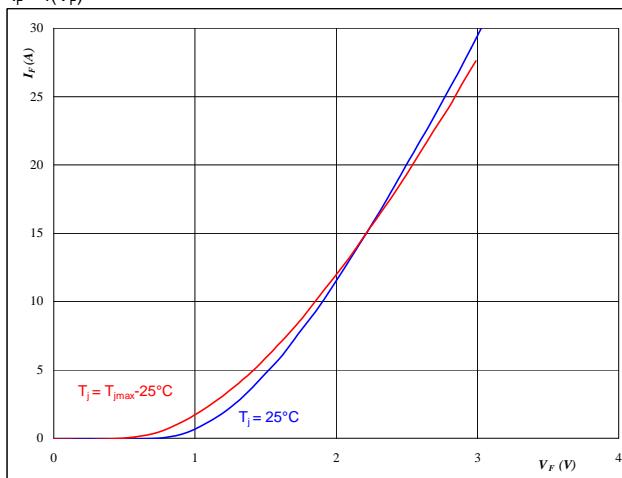

At

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

Brake IGBT
Figure 4
Typical diode forward current as
a function of forward voltage

$$I_F = f(V_F)$$


At

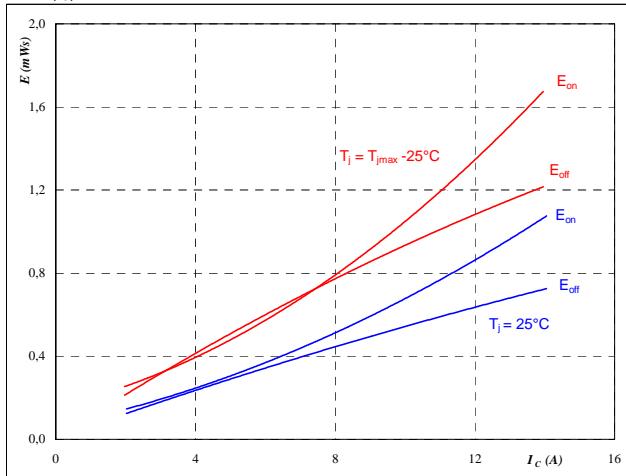
$$t_p = 250 \mu\text{s}$$

Brake

Figure 5

**Typical switching energy losses
as a function of collector current**

$$E = f(I_C)$$



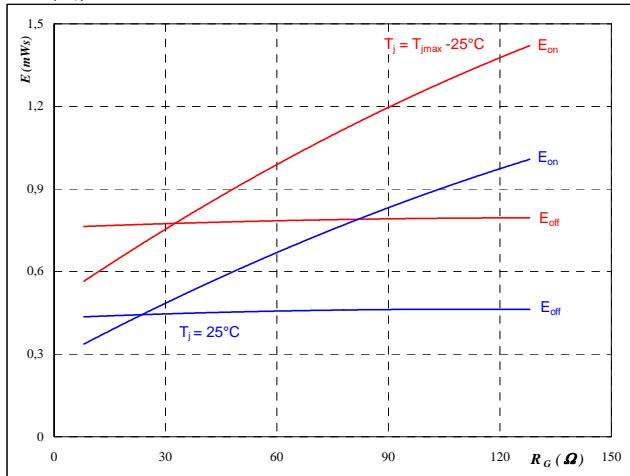
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \\ R_{goff} &= 32 \quad \Omega \end{aligned}$$

Brake IGBT
Figure 6

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



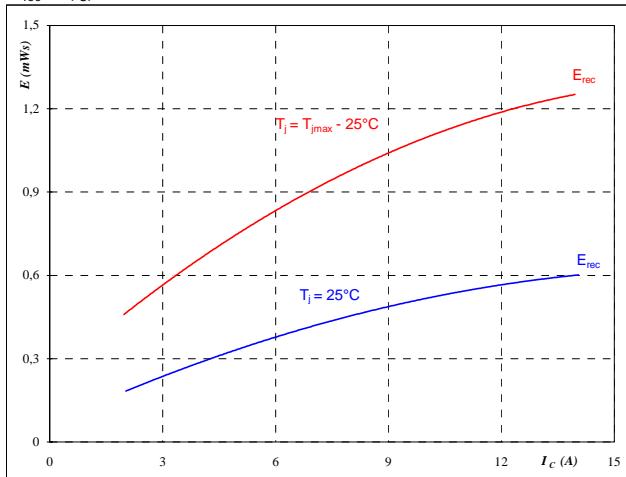
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 8 \quad \text{A} \end{aligned}$$

Figure 7

**Typical reverse recovery energy loss
as a function of collector current**

$$E_{rec} = f(I_C)$$



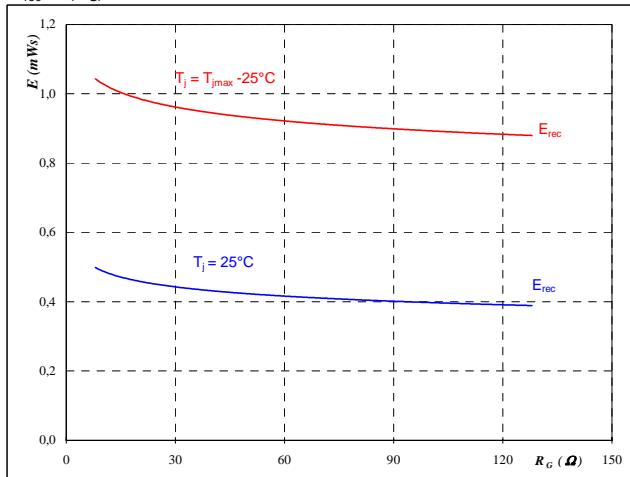
With an inductive load at

$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

Brake FWD
Figure 8

**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

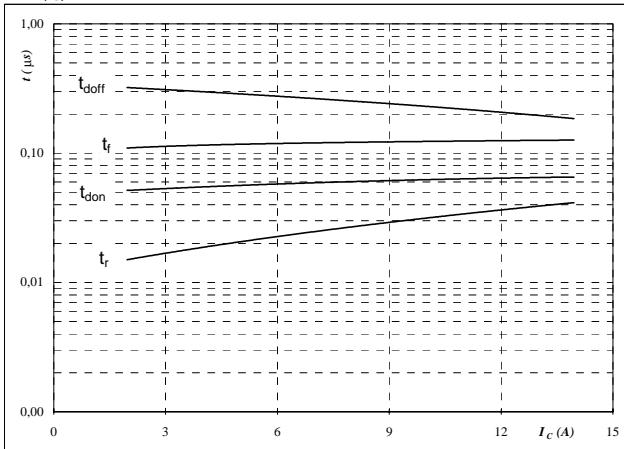
$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 8 \quad \text{A} \end{aligned}$$

Brake

Figure 9

Typical switching times as a function of collector current

$$t = f(I_C)$$



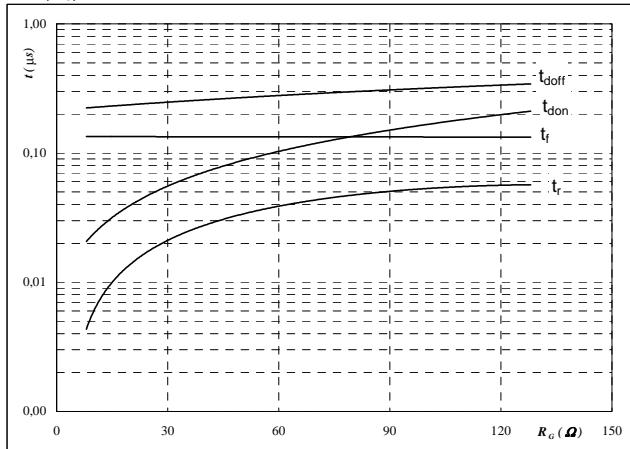
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	32	Ω

Brake IGBT
Figure 10

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	8	A

Figure 11

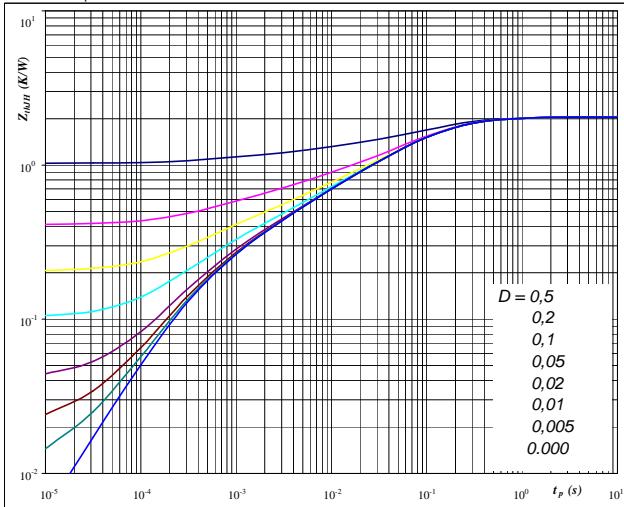
IGBT transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$

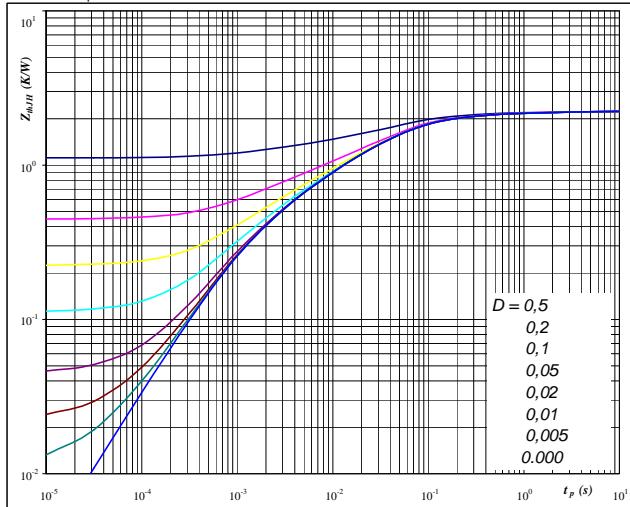
Brake IGBT
Figure 12

FWD transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At Thermal grease $D = tp / T$
 $R_{thJH} = 2,05$ K/W $R_{thJH} = 1,66$ K/W



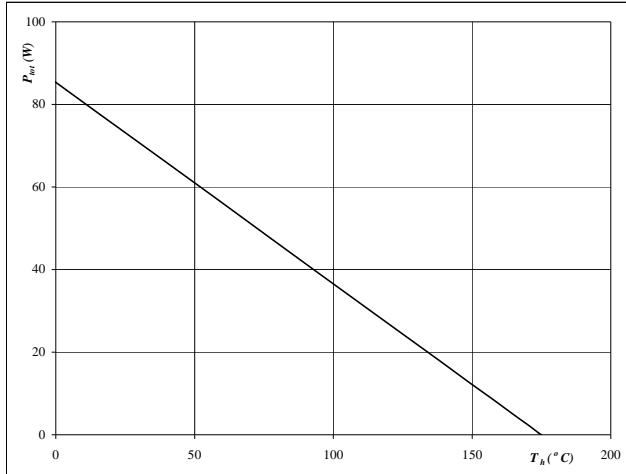
At Thermal grease $D = tp / T$
 $R_{thJH} = 2,23$ K/W $R_{thJH} = 1,81$ K/W

Brake

Figure 13

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$

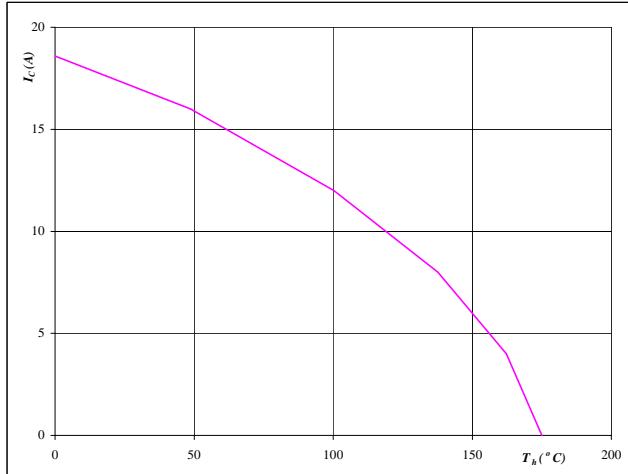

At

$$T_j = 175 \quad {}^\circ\text{C}$$

Brake IGBT
Figure 14

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$


At

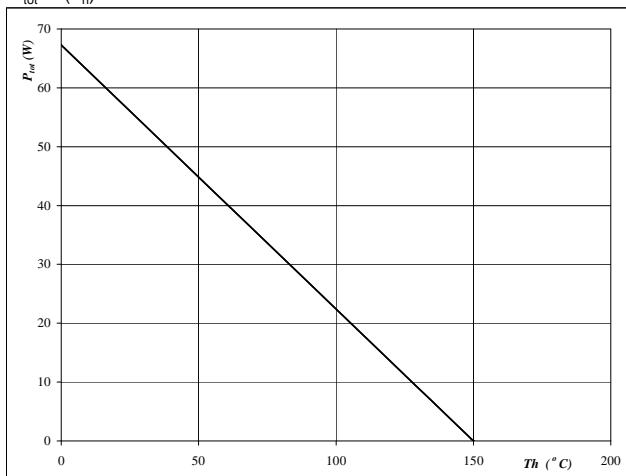
$$T_j = 175 \quad {}^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

Figure 15

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$

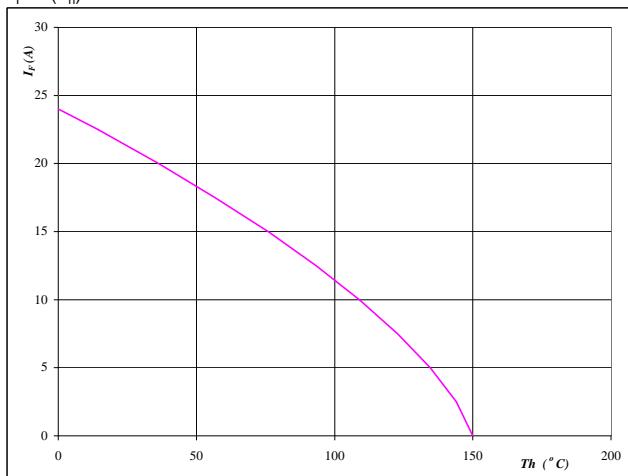

At

$$T_j = 150 \quad {}^\circ\text{C}$$

Brake FWD
Figure 16

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$


At

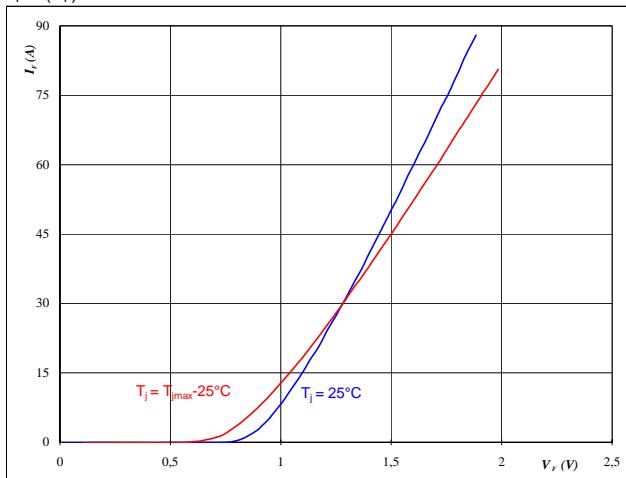
$$T_j = 150 \quad {}^\circ\text{C}$$

Input Rectifier Bridge

Figure 1

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

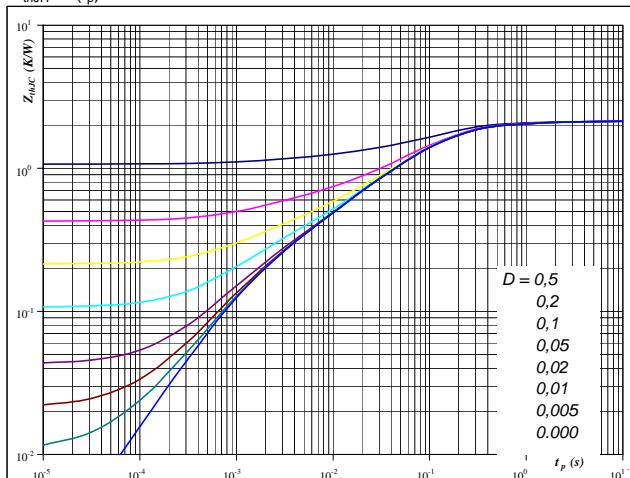

At

$$t_p = 250 \mu\text{s}$$

Rectifier diode
Figure 2

Diode transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$


At

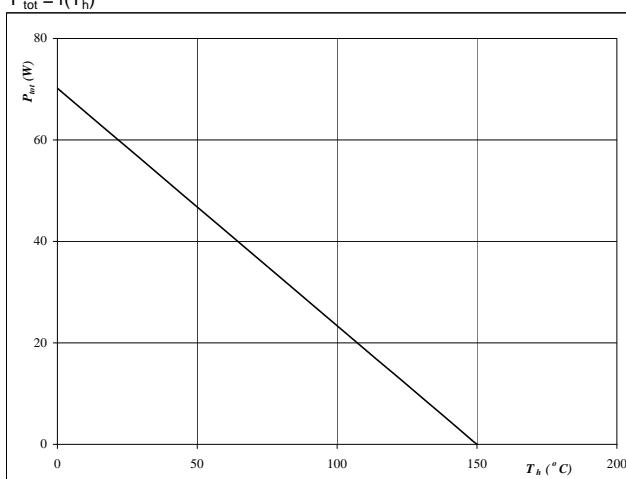
$$D = t_p / T$$

$$R_{thJH} = 2,137 \text{ K/W}$$

Rectifier diode
Figure 3

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

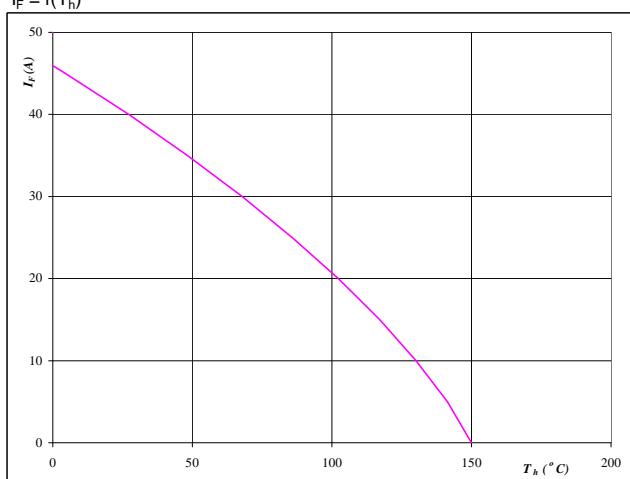

At

$$T_j = 150 ^\circ\text{C}$$

Rectifier diode
Figure 4

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$


At

$$T_j = 150 ^\circ\text{C}$$

Rectifier diode

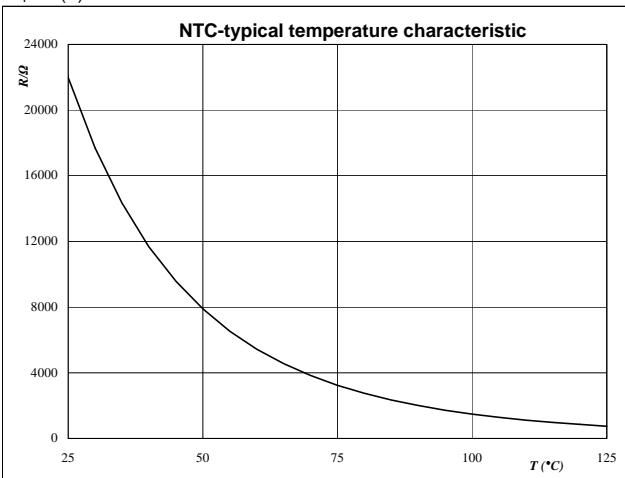
Thermistor

Figure 1

Thermistor

**Typical NTC characteristic
as a function of temperature**

$$R_T = f(T)$$



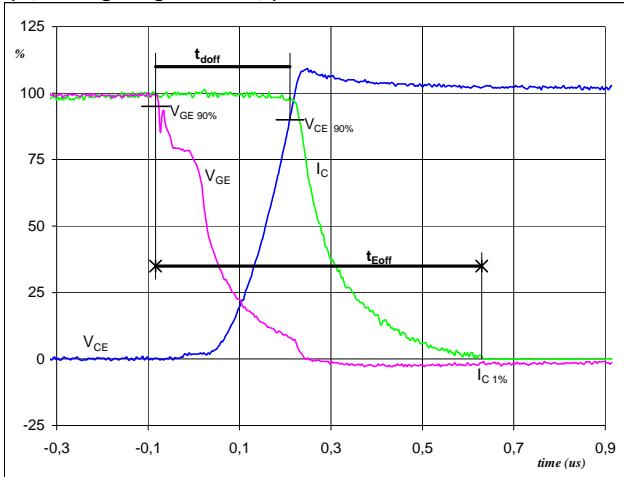
Switching Definitions Output Inverter

General conditions

T_j	=	150 °C
R_{gon}	=	32 Ω
R_{goff}	=	32 Ω

Figure 1

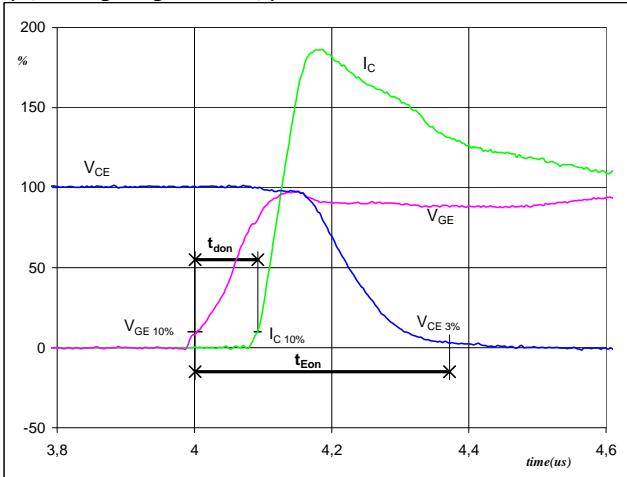
Output inverter IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
(t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%) = -15 \text{ V}$
 $V_{GE}(100\%) = 15 \text{ V}$
 $V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 15 \text{ A}$
 $t_{doff} = 0,29 \mu\text{s}$
 $t_{Eoff} = 0,71 \mu\text{s}$

Figure 2

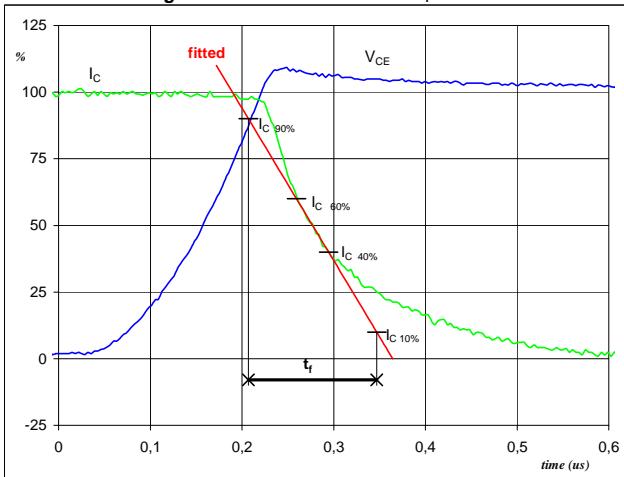
Output inverter IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
(t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%) = -15 \text{ V}$
 $V_{GE}(100\%) = 15 \text{ V}$
 $V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 15 \text{ A}$
 $t_{don} = 0,09 \mu\text{s}$
 $t_{Eon} = 0,37 \mu\text{s}$

Figure 3

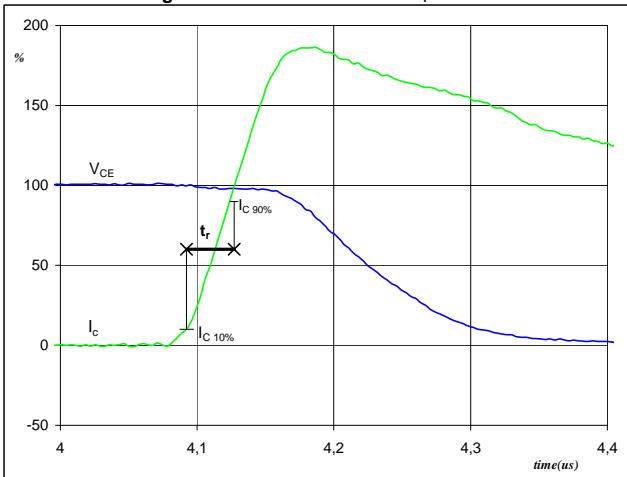
Output inverter IGBT
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 15 \text{ A}$
 $t_f = 0,14 \mu\text{s}$

Figure 4

Output inverter IGBT
Turn-on Switching Waveforms & definition of t_r

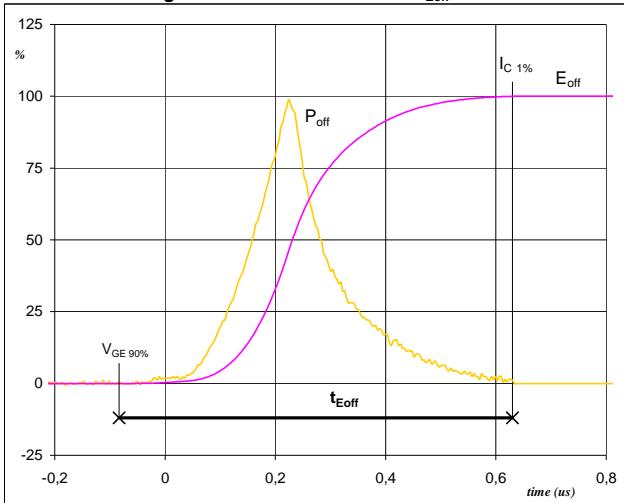


$V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 15 \text{ A}$
 $t_r = 0,03 \mu\text{s}$

Switching Definitions Output Inverter

Figure 5

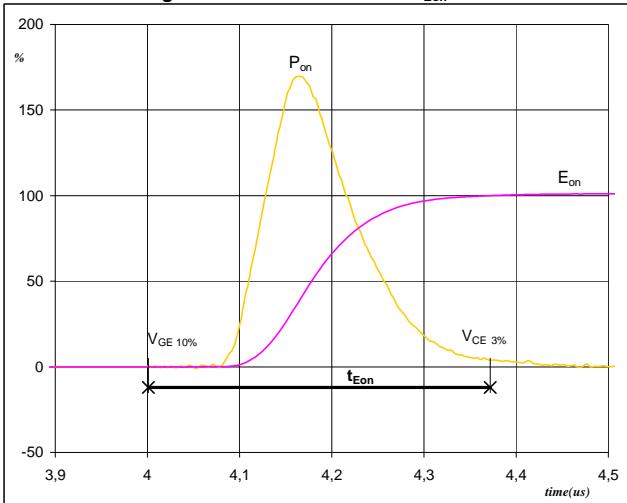
Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{Eoff} 

P_{off} (100%) = 9,02 kW
 E_{off} (100%) = 1,53 mJ
 t_{Eoff} = 0,71 μ s

Figure 6

Output inverter IGBT

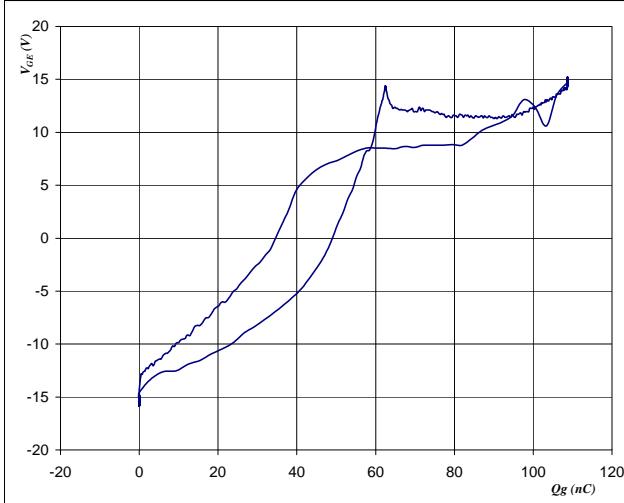
Turn-on Switching Waveforms & definition of t_{Eon} 

P_{on} (100%) = 9,02 kW
 E_{on} (100%) = 1,78 mJ
 t_{Eon} = 0,37 μ s

Figure 7

Output inverter FWD

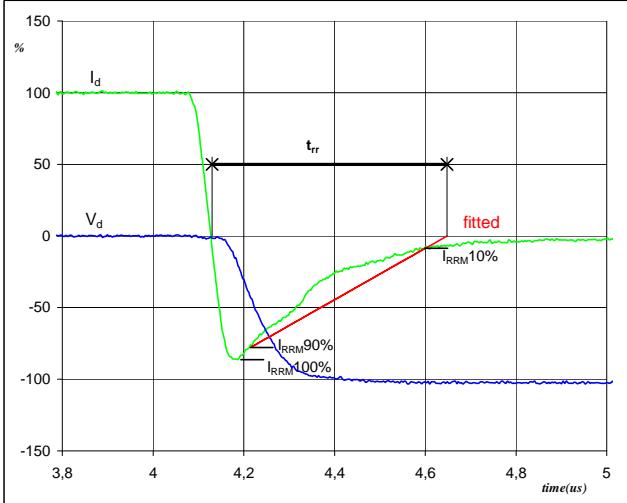
Gate voltage vs Gate charge (measured)



V_{GEoff} = -15 V
 V_{GEon} = 15 V
 V_C (100%) = 600 V
 I_C (100%) = 15 A
 Q_g = 108,88 nC

Figure 8

Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{rr} 

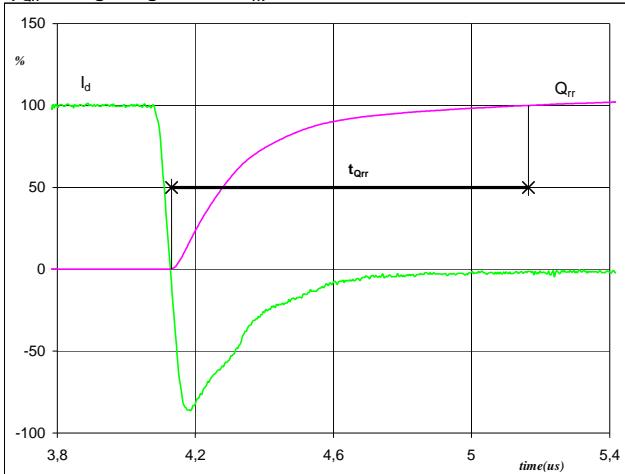
V_d (100%) = 600 V
 I_d (100%) = 15 A
 I_{RRM} (100%) = -13 A
 t_{rr} = 0,51 μ s

Switching Definitions Output Inverter

Figure 9

Output inverter FWD

Turn-on Switching Waveforms & definition of t_{Qrr}
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$

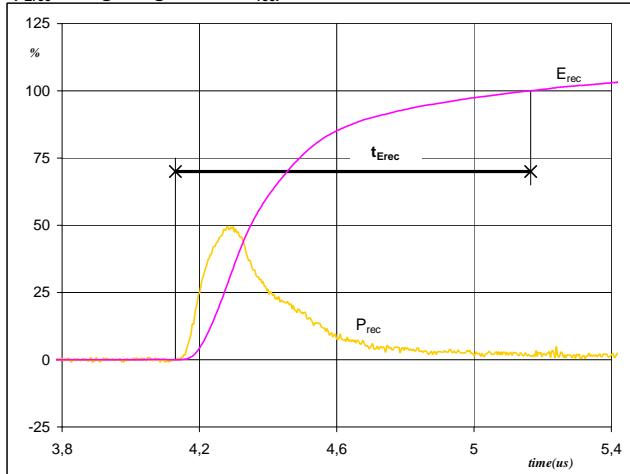


$I_d(100\%) = 15 \text{ A}$
 $Q_{rr}(100\%) = 3,04 \mu\text{C}$
 $t_{Qrr} = 1,03 \mu\text{s}$

Figure 10

Output inverter FWD

Turn-on Switching Waveforms & definition of t_{Erec}
 $(t_{Erec} = \text{integrating time for } E_{rec})$



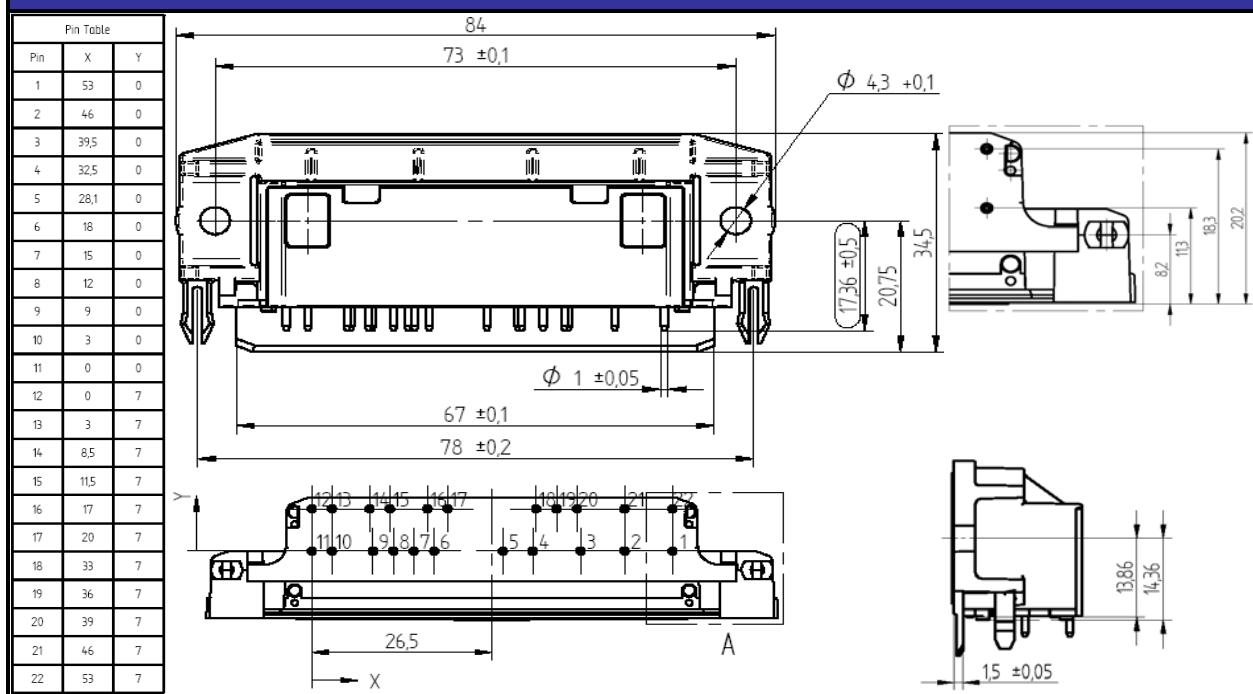
$P_{rec}(100\%) = 9,02 \text{ kW}$
 $E_{rec}(100\%) = 1,22 \text{ mJ}$
 $t_{Erec} = 1,03 \mu\text{s}$

Ordering Code and Marking - Outline - Pinout

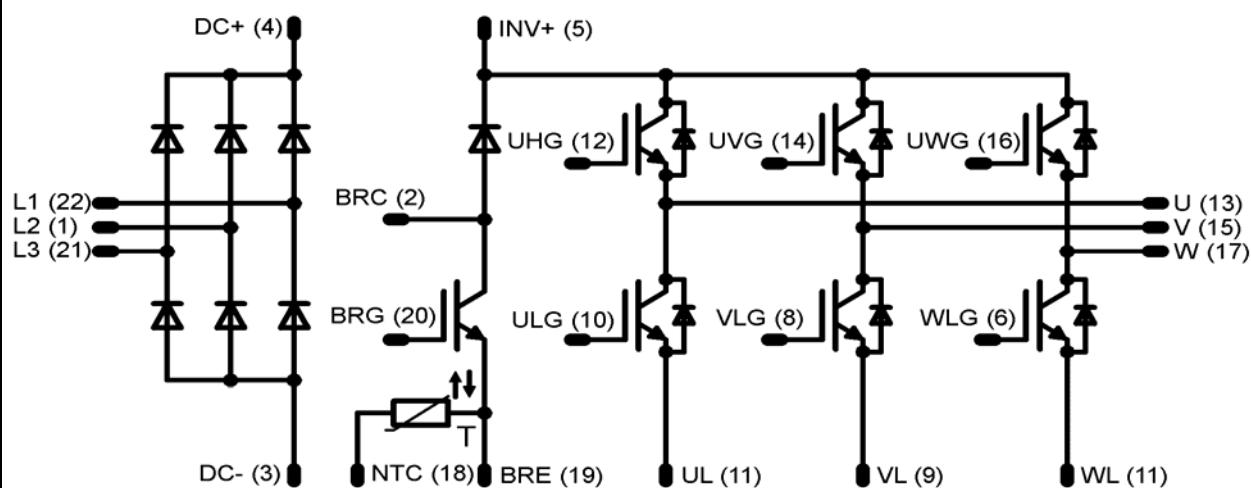
Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	V23990-P630-A40	P630-A40	P630-A40

Outline



Pinout



PRODUCT STATUS DEFINITIONS

Datasheet Status	Product Status	Definition
Target	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. The data contained is exclusively intended for technically trained staff.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data may be published at a later date. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.
Final	Full Production	This datasheet contains final specifications. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.